



REV.	ECN NO.	REVISED	DATE

NOTE:

1.MATERIAL:

a.HOUSING:PPA

b.CONTACT:PHOSPHOR BRONZE

(SURFACE PLATING: Au1u")

SEE ORDERING INFORMATION

2.ELECTRIC:

a.CONTACT RESISTANCE: 30 MILLIOHMS MAX

b.INSULATION RESISTANCE: 100 MEGA OHMS MIN

c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL

d.OPERATING TEMPERATURE: -25°C~ +85°C

ORDERING INFORMATION

BS-2016-B***001

电池座系列

BS-2016系列

SMT 180° TYPE

PLATING:

A-Au1U"

J-Ni100U"~120U"

K-Sn100U"~120U"

MATERIAL:

1A-PBT BLACK

1B-PA66 BLACK

2A-PPA BROWN

2B-PPA BLACK

3A-PPS BROWN

3B-PPS BLACK

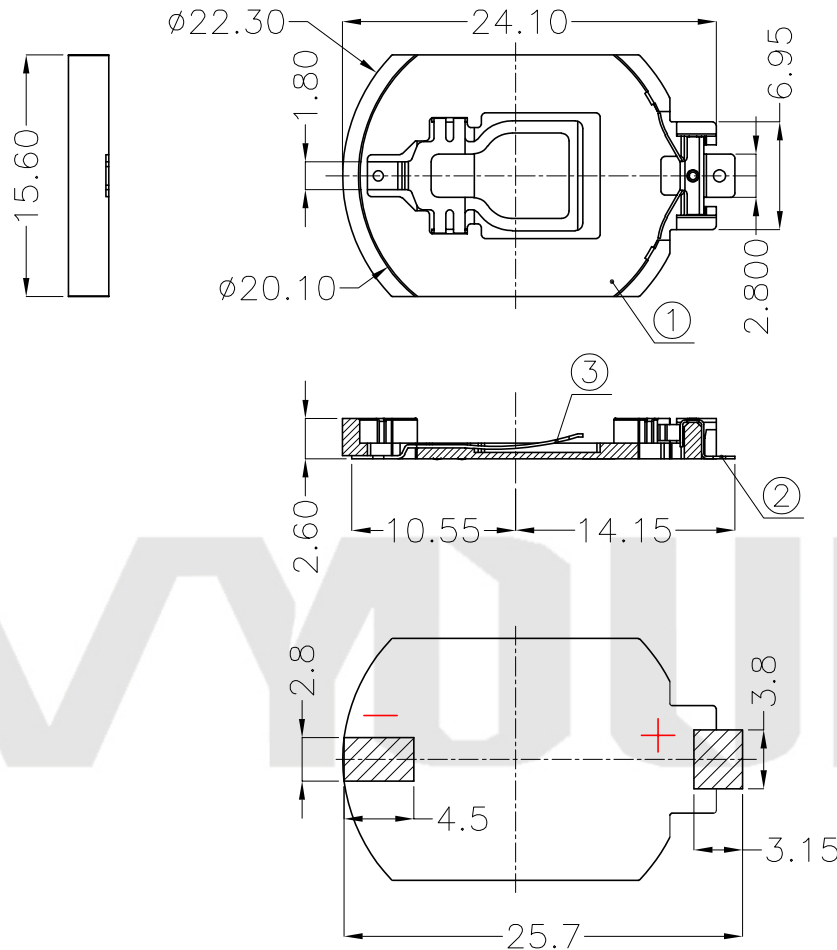
4A-LCP WHITE

4B-LCP BLACK

工程部

2017-07-15

ZW DANG



PCB Layout Diagram
Top View

3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
1	HOUSING	1	PPA	BROWN
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		MYOUNG 美用 www.meiyangdz.com			
DECIMALS:	ANGLES:	DSND	YangFeng	DATE	2017-07-15
X :±0.30	X :±1°	CHKD	ZhouRuicai	DATE	2017-07-15
X.X :±0.25	X.X :±0.5°	APVD	XueShunyang	DATE	2017-07-15
X.XX :±0.20		WEIGHT:	0.66g	SCALE:	2:1
X.XXX :±0.10		SHEET	1 OF 1	SIZE:	A4
		UNIT:	mm	VIEW:	⊙ ⊞
		REV.:	A/0	OBJECT:	MY
				DRAW NO.:	MY-CP-0029